

## **Technical Data Sheet**

# 0603 Package Chip LED(0.8mm Height)

#### **Features**

#### 19-21/R6C-FP1Q2L/3T

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free
- The product itself will remain within RoHS compliant version.

### **Descriptions**

- The 19-21 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

### **Applications**

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

#### **Device Selection Guide**

David Nia	Chip	F:44 - J.Cl	Resin Color	
Part No.	Material	Emitted Color		
19-21/R6C-FP1Q2L/3T	AlGaInP	Brilliant Red	Water Clear	

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 1 of 10 Device No: SZDSE-191-R12 Prepared date:22-Mar-2007 Prepared by: Yuan Shaoxiang

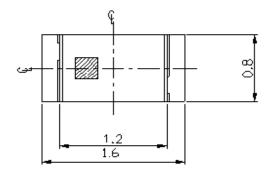
Revision Release Date: 2008-09-20 00:16:10.0 : 1 LifecyclePhase:正式發行

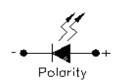


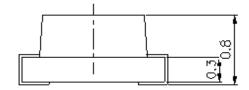
**Expired Period: Forever** 



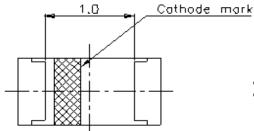
## **Package Outline Dimensions**

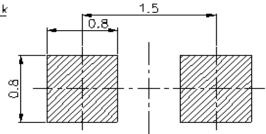






For reflow soldering





**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

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Rev.1 Page: 2 of 10

Device No: SZDSE-191-R12

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**Revision**: 1

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## **Absolute Maximum Ratings (Ta=25)**

Parameter	Symbol	Rating	Unit	
Reverse Voltage	$V_R$	5	V	
Forward Current	$I_{F}$	25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	$ m I_{FP}$	60	mA	
Power Dissipation	Pd	60	mW	
Electrostatic Discharge(HBM)	ESD	2000	V	
Operating Temperature	T <sub>opr</sub>	-40 ~ +85		
Storage Temperature	T <sub>Stg</sub>	-40 ~ +90		
Soldering Temperature	T <sub>SOl</sub>	Reflow Soldering Hand Soldering		

### **Electro-Optical Characteristics (Ta=25)**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	$I_{V}$	45.0	-1	112	mcd	1
Viewing Angle	2 1/2	1	100	J#7	deg	
Peak Wavelength	p	4	632		nm	
Dominant Wavelength	d	621		631	nm	I <sub>F</sub> =20mA
Spectrum Radiation Bandwidth	)		20		nm	
Forward Voltage	$V_{\mathrm{F}}$	1.70		2.30	V	
Reverse Current	$I_R$			10	μА	V <sub>R</sub> =5V

#### **Notes:**

1.Tolerance of Luminous Intensity ±11%

2. Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.05V

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 3 of 10

Device No: SZDSE-191-R12 Prepared date:22-Mar-2007 Prepared by: Yuan Shaoxiang

Revision : 1 Release Date:2008-09-20 00:16:10.0



Page: 4 of 10

### Bin Range Of Dom. Wavelength

		0			
Group	Bin	Min	Max	Unit	Condition
F	FF1	621	626		I 20 A
	FF2	626	631	nm	$I_F=20mA$

### **Bin Range Of Luminous Intensity**

Bin	Min	Max	Unit	Condition
P1	45.0	57.0	mcd	I <sub>F</sub> =20mA
P2	57.0	72.0		
Q1	72.0	90.0		
Q2	90.0	112		

### **Bin Range Of Forward Voltage**

Group	Bin	Min	Max	Unit	Condition	
L	19	1.70	1.80	TITT		
	20	1.80	1.90		I <sub>F</sub> =20mA	
	21	1.90	2.00	17		
	22	2.00	2.10	V		
	23	2.10	2.20			
	24	2.20	2.30			

#### **Notes:**

1. Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm

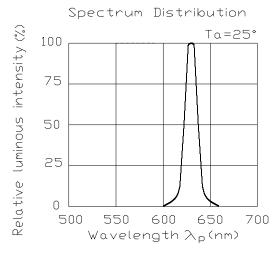
3.Tolerance of Forward Voltage ±0.05V

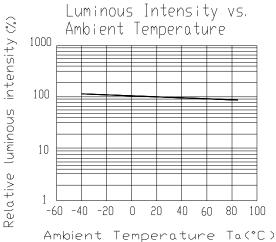
Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1

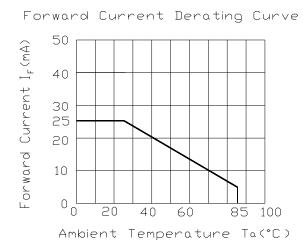
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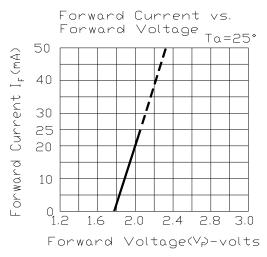
Revision : 1 Release Date:2008-09-20 00:16:10.0

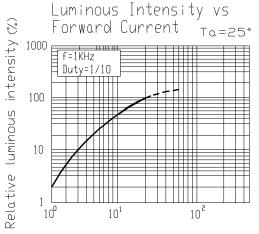
#### **Typical Electro-Optical Characteristics Curves**

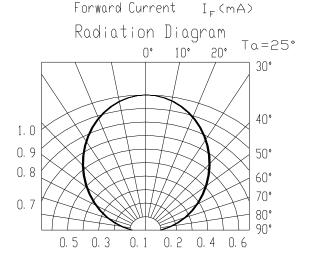












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Rev.1

Release Date:2008-09-20 00:16:10.0

Page: 5 of 10

Device No: SZDSE-191-R12

Prepared date:22-Mar-2007

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Revision: 1

### Label explanation

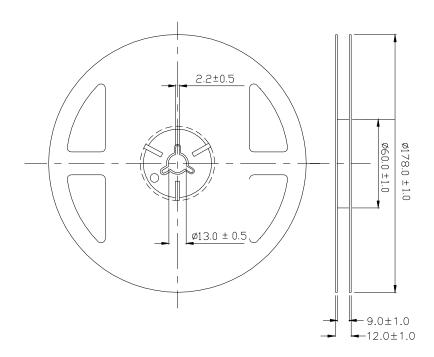
**CAT: Luminous Intensity Rank** 

**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 



#### **Reel Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

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Rev.1 Page: 6 of 10

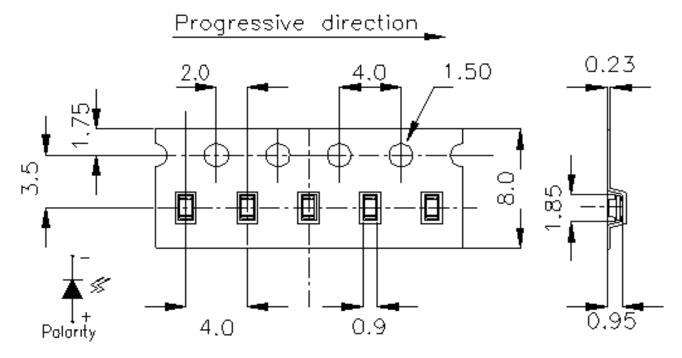
Device No: SZDSE-191-R12 Prepared date:22-Mar-2007

Prepared by: Yuan Shaoxiang

Revision : 1 Release Date:2008-09-20 00:16:10.0

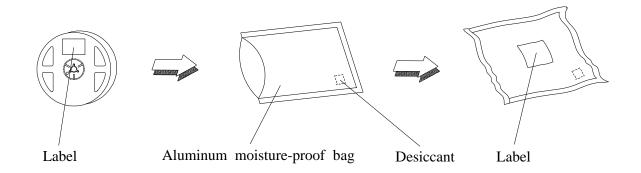


## Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

# **Moisture Resistant Packaging**



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Device No: SZDSE-191-R12

http://www.everlight.com

Prepared date:22-Mar-2007

Rev.1

Page: 7 of 10

Prepared by: Yuan Shaoxiang

Revision : 1 Release Date:2008-09-20 00:16:10.0



## **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp.: 260 ±5 Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H: +100 15min 5 min L: -40 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100 5min 10 sec L: -10 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp.: 100	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85 / 85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 8 of 10

Device No: SZDSE-191-R12 Prepared date:22-Mar-2007 Prepared by: Yuan Shaoxiang

Revision : 1 Release Date:2008-09-20 00:16:10.0

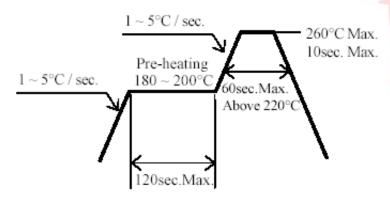
#### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
  - 2.2 Before opening the package: The LEDs should be kept at 30 or less and 90%RH or less.
  - 2.3 After opening the package: The LED's floor life is 1 year under 30 or less and 60% RH or less.

    If unused LEDs remain, it should be stored in moisture proof packages.
  - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment: 60±5 for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 9 of 10

Device No: SZDSE-191-R12 Prepared date:22-Mar-2007 Prepared by: Yuan Shaoxiang

Revision : 1 Release Date:2008-09-20 00:16:10.0

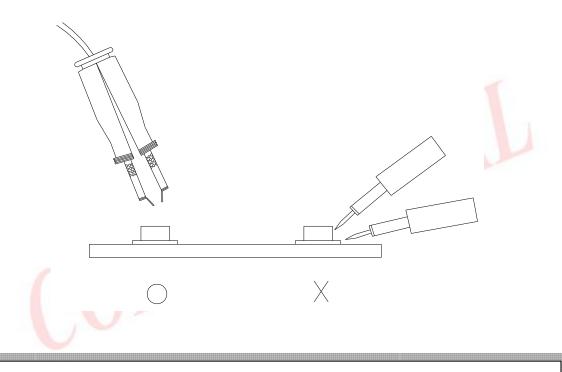


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 10 of 10

Device No: SZDSE-191-R12 Prepared date:22-Mar-2007 Prepared by: Yuan Shaoxiang

Revision : 1 Release Date:2008-09-20 00:16:10.0